THE DATASHEET OF

UCLAMP2501T.TCT

uClamp2501T
Low Voltage µClamp®
2.5V TVS Diode

Description

The µClamp® series of Transient Voltage Suppressors (TVS) are designed to replace multilayer varistors (MLVs) in portable applications such as cell phones, notebook computers, and PDAs. They offer superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLVs. They are designed to protect sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD), lightning, electrical fast transients (EFT), and cable discharge events (CDE).

The µClamp®2501T is constructed using Semtech's proprietary EPD TVS process technology. The EPD process provides low operating voltages with significant reductions in leakage currents and capacitance over silicon-avalanche diode processes. They feature a true sub 5 volt operating voltage for superior protection when compared to traditional pn junction devices.

The µClamp2501T is in a 2-pin SLP1006P2T package. It measures 1.0 x 0.6 x 0.4mm. The leads are spaced at a pitch of 0.65mm and are finished with lead-free NiPdAu. Each device will protect one line operating at 2.5 volts. It gives the designer the flexibility to protect single lines in applications where arrays are not practical. They may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (±15kV air, ±8kV contact discharge). The combination of small size and high ESD surge capability makes them ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Features

- Transient protection for data lines to
  IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
  IEC 61000-4-4 (EFT) 40A (tp = 5/50ns)
  Cable Discharge Event (CDE)
- Ultra-small package (1.0 x 0.6 x 0.4mm)
- Low leakage current: <10nA typical (VR=2.5V)
- Low Operating voltage: 2.5V
- Low capacitance
- Protects one data line
- Solid-state silicon-avalanche technology

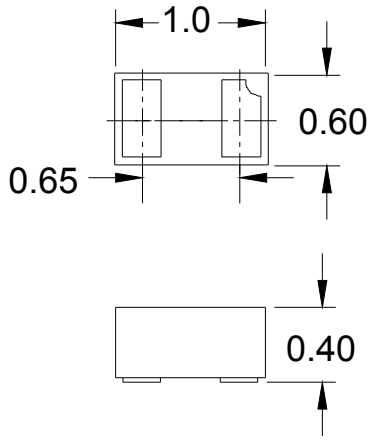
Mechanical Characteristics

- SLP1006P2T package
- Pb-Free, Halogen Free, RoHS/WEEE Compliant
- Nominal Dimensions: 1.0 x 0.6 x 0.4 mm
- Lead Finish: NiPdAu
- Molding compound flammability rating: UL 94V-0
- Marking : Marking code, cathode band
- Packaging : Tape and Reel

Applications

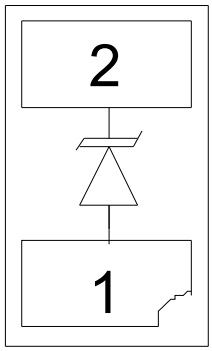
- Cellular Handsets & Accessories
- Portable Instrumentation
- Keypads, Side Keys, LCD Displays
- Notebooks & Desktop Computers
- mp3 Players

Dimensions



Nominal Dimensions (mm)

Schematic & PIN Configuration



SLP1006P2T (Bottom View)

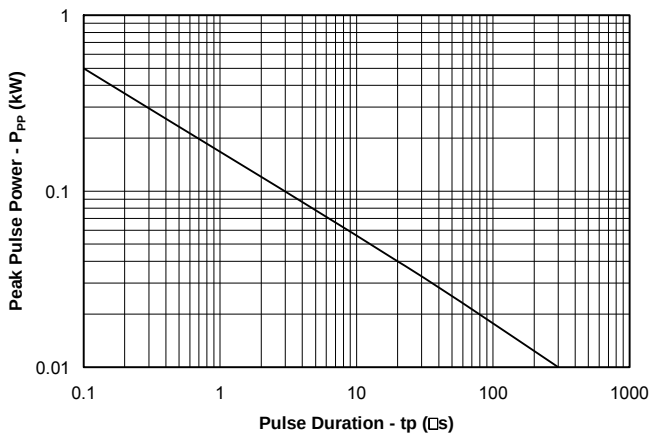
Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P_{pk}	40	Watts
Maximum Peak Pulse Current (tp = 8/20μs)	I_{pp}	5	Amps
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	+/- 20 +/- 15	kV
Operating Temperature	T_J	-40 to +85	°C
Storage Temperature	T_{STG}	-55 to +150	°C

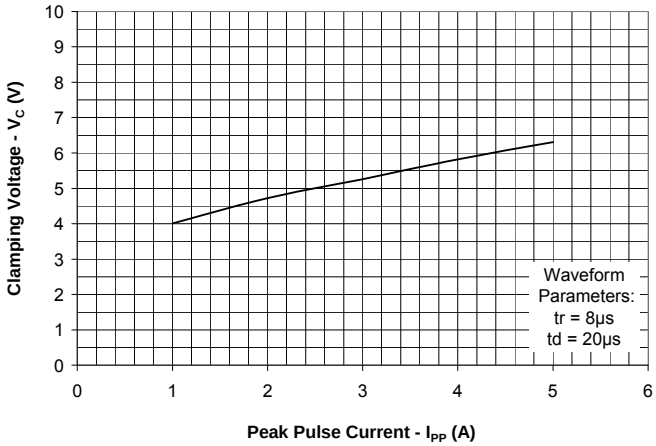
Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				2.5	V
Punch-Through Voltage	V_{PT}	I_{PT} = 2μA	2.7	3.1	3.6	V
Snap-Back Voltage	V_{SB}	I_{SB} = 50mA	2.8			V
Reverse Leakage Current	I_R	V_{RWM} = 2.5V		0.01	0.05	μA
Clamping Voltage	V_C	I_{PP} = 1A, tp = 8/20μs			5	V
Clamping Voltage	V_C	I_{PP} = 5A, tp = 8/20μs			7.5	V
Forward Voltage	V_F	I_{PP} = 1A, tp = 8/20μs			2.4	V
Junction Capacitance	C_j	Pin 2 to 1 V_R = 0V, f = 1MHz		25	30	pF
		Pin 2 to 1 V_R = 2.5V, f = 1MHz		14		pF

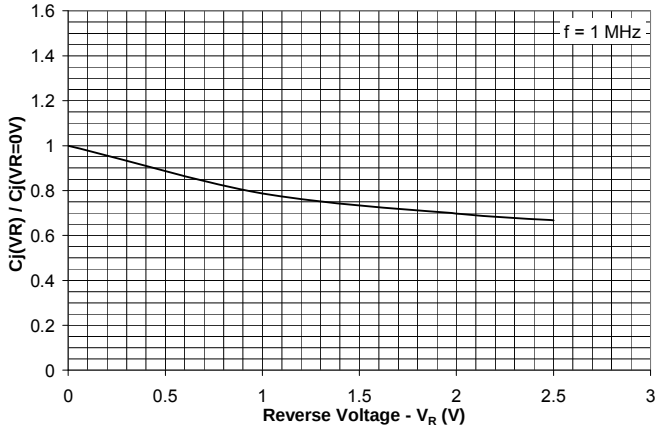
Non-Repetitive Peak Pulse Power vs. Pulse Time



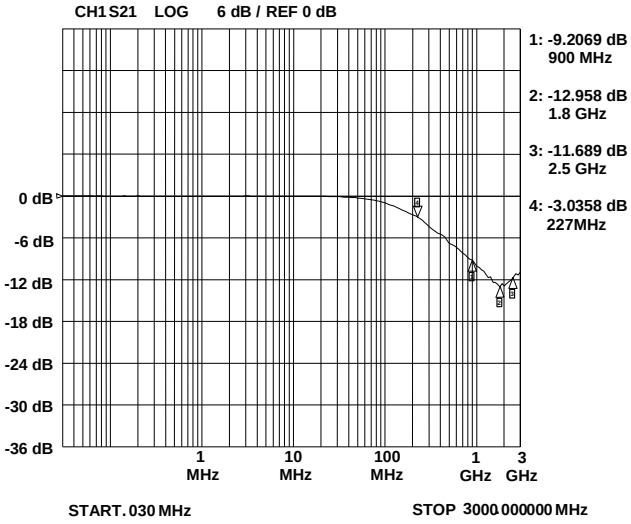
Clamping Voltage vs. Peak Pulse Current



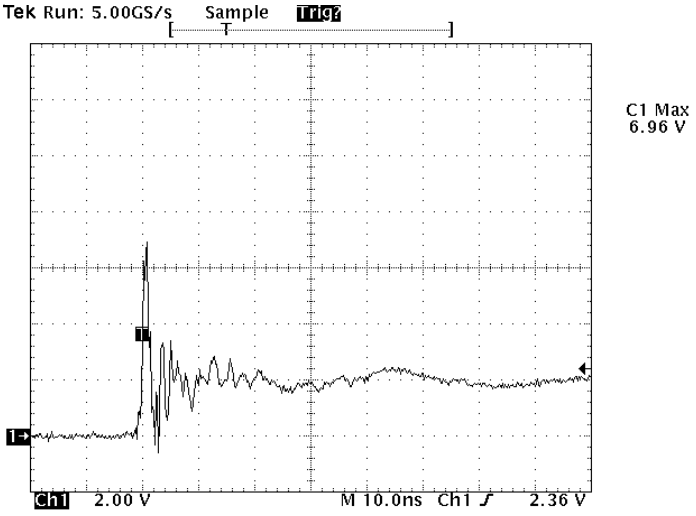
Normalized Junction Capacitance vs. Reverse Voltage



Typical Insertion Loss (S21)

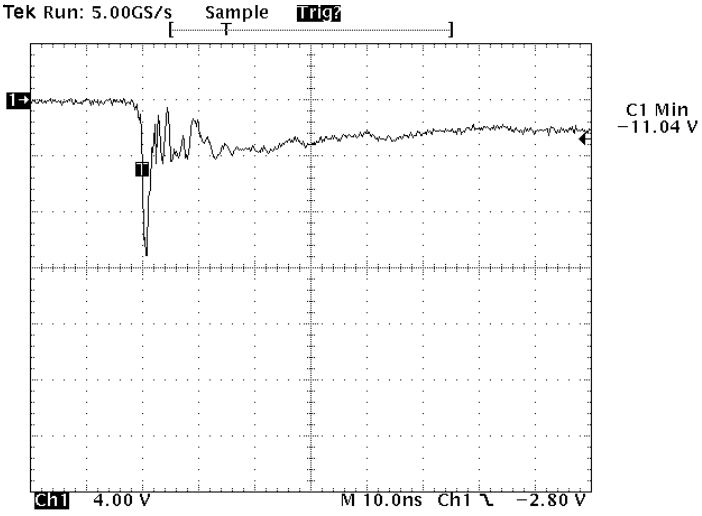


ESD Clamping (Pin 2 to 1)
(8kV Contact per IEC 61000-4-2)



Note: Data is taken with a 10x attenuator

ESD Clamping (Pin 1 to 2)
(-8kV Contact per IEC 61000-4-2)



Note: Data is taken with a 10x attenuator

Applications Information

Device Connection Options

The µClamp2501T is designed to protect one data line operating up to 2.5 volts. It will present a high impedance to the protected line up to 2.5 volts. It will "turn on" when the line voltage exceeds 2.7 volts. The device is unidirectional and may be used on lines where the signal polarity is above ground. These devices are not recommended for use on DC power supply lines due to their snap-back voltage characteristic.

EPD TVS Characteristics

These devices are constructed using Semtech's proprietary EPD technology. The structure of the EPD TVS is vastly different from the traditional pn-junction devices. At voltages below 5V, high leakage current and junction capacitance render conventional avalanche technology impractical for most applications. However, by utilizing the EPD technology, these devices can effectively operate at 2.5V while maintaining excellent electrical characteristics.

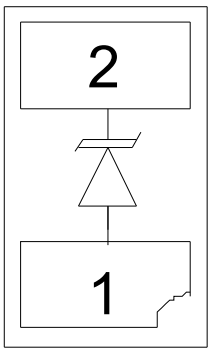
The EPD TVS employs a complex nppn structure in contrast to the pn structure normally found in traditional silicon-avalanche TVS diodes. The EPD mechanism is achieved by engineering the center region of the device such that the reverse biased junction does not avalanche, but will "punch-through" to a conducting state. This structure results in a device with superior DC electrical parameters at low voltages while maintaining the capability to absorb high transient currents.

Circuit Board Layout Recommendations for Suppression of ESD.

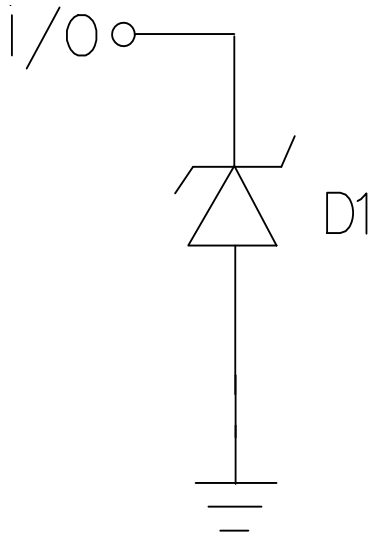
Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- Minimize all conductive loops including power and ground loops.
- The ESD transient return path to ground should be kept as short as possible.
- Never run critical signals near board edges.
- Use ground planes whenever possible.

Device Schematic & Pin Configuration



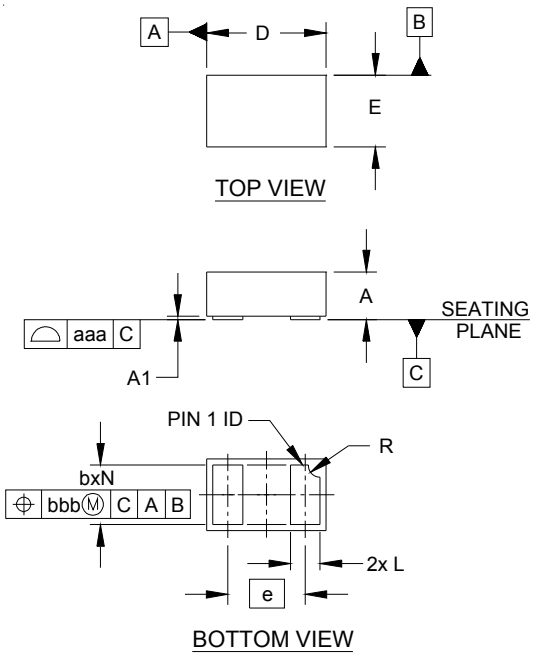
Applications Information - Spice Model



Spice Model

uClamp2501T Spice Parameters		
Parameter	**Unit**	**D1 (TVS)**
IS	Amp	9.5E-15
BV	Volt	2.81
VJ	Volt	0.72
RS	Ohm	0.707
IBV	Amp	1.0E-3
CJO	Farad	23E-12
TT	sec	2.541E-9
M	--	0.18
N	--	1.1
EG	eV	1.11

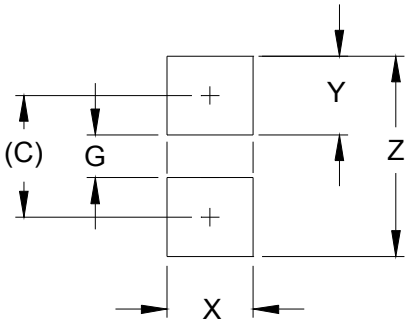
Outline Drawing - SLP1006P2T



DIMENSIONS						
DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.015	.016	.017	0.37	0.40	0.43
A1	.000	.001	.002	0.00	0.03	0.05
b	.018	.020	.022	0.45	0.50	0.55
D	.035	.039	.043	0.90	1.00	1.10
E	.020	.024	.028	0.50	0.60	0.70
e	.026 BSC			0.65 BSC		
L	.008	.010	.012	0.20	0.25	0.30
R	.002	.004	.006	0.05	0.10	0.15
N	2			2		
aaa	.003			0.08		
bbb	.004			0.10		

NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

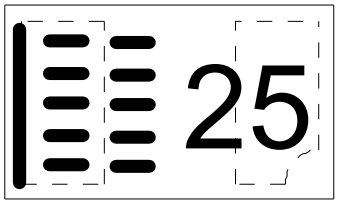
Land Pattern - SLP1006P2T



DIMENSIONS		
DIM	INCHES	MILLIMETERS
C	(.033)	(0.85)
G	.012	0.30
X	.024	0.60
Y	.022	0.55
Z	.055	1.40

NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

Marking Code



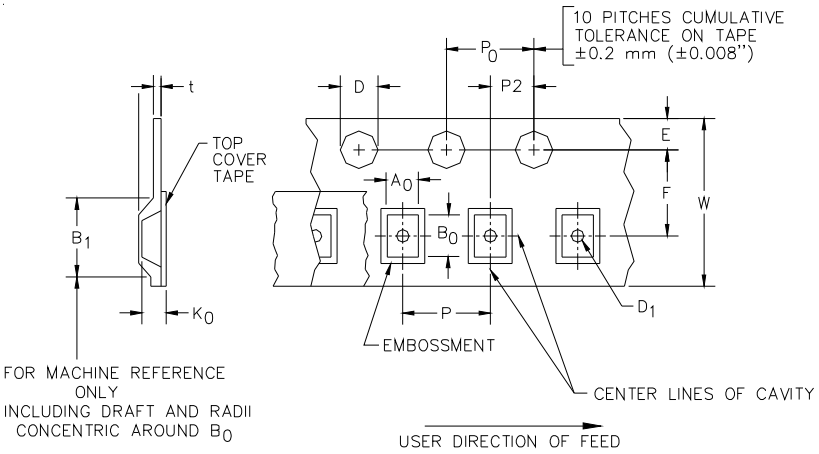
Notes:
1) Marking will also include line matrix date code

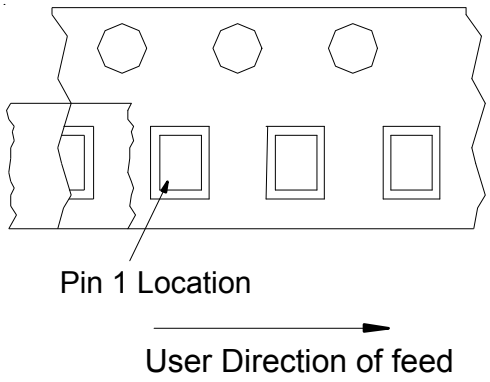
Ordering Information

Part Number	Working Voltage	Qty per Reel	Reel Size
uClamp2501T.TCT	2.5V	3,000	7 Inch

Notes:
1) MicroClamp, uClamp and µClamp are marks of Semtech Corporation

Tape and Reel Specification





Device Orientation in Tape

A0	B0	K0
0.69 +/-0.10 mm	1.19 +/-0.10 mm	0.66 +/-0.10 mm

Tape Width	B, (Max)	D	D1	E	F	P	P0	P2	T	W
8 mm	4.2 mm (.165)	1.5 + 0.1 mm - 0.0 mm (0.59 +.005 - .000)	0.4 mm ±0.25 (.031)	1.750±.10 mm (.069±.004)	3.5±0.05 mm (.138±.002)	4.0±0.10 mm (.157±.00-4)	4.0±0.1 mm (.157±.00-4)	2.0±0.05 mm (.079±.002)	0.254±0.02 mm (.016)	8.0 mm + 0.3 mm - 0.1 mm (.312±.012)

Contact Information

Semtech Corporation
Protection Products Division
200 Flynn Rd., Camarillo, CA 93012
Phone: (805)498-2111 FAX (805)498-3804

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

- View UCLAMP2501T.TCT on WIN SOURCE
- Semtech Corporation Information

Optimize Your Supply Chain with WIN SOURCE Solutions

- Global Sourcing Solution
- Obsolete Management
- Cost Control Management
- Shortage Management
- Alternative Solution
- Excess Inventory Management